

**Jay R. Bombien**

Attorney
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Jay R. Bombien counsels clients on all types of patent-related matters while focusing on securing patent rights in electrical, computer, and mechanical technologies including medical imaging systems, autonomous driving, factory automation, wireless communication systems, semiconductor devices and fabrication, printing systems and devices, electronic displays and driving circuitry, medical and biomedical devices, automotive control systems, and magnetoresistive devices.

In this role, Jay prepares and prosecutes utility and design patent applications in the United States and internationally for a broad range of clients, from independent inventors and start-ups to Fortune 500 companies.

Jay regularly conducts analysis and drafting of non-infringement, patentability, and validity opinions. Jay also conducts IP due diligence in connection with mergers and acquisitions and advises clients in association with IP litigation.

Education

University of Wisconsin - Milwaukee
2006, B.S., Electrical Engineering

Western Michigan University – Cooley Law School
2009, J.D.

Admissions**Bar Admissions**

District of Columbia
Illinois
Virginia

Court Admissions

District of Columbia Court of Appeals
Superior Court of the District of Columbia
U.S. Patent and Trademark Office

Practices

Counseling, Opinions + Licensing

Design Patents
PTAB Litigation
Patent Prosecution

Industries

Electrical + Computer Technologies
Medical Devices

Accolades

- Recognized in "Best Lawyers in America: Ones to Watch," 2021-2025

Recent News + Events + Related Publications

NEWS - 11.14.25

PTAB Highlights | Takeaways from Recent Decisions in Post-Issuance Proceedings

NEWS - 01.27.25

Banner Witcoff Elects New President, Board Members, and Shareholders

NEWS - 08.15.24

Banner Witcoff Attorneys Named to Best Lawyers in America Guide

Featured, Non-news/events/press, general content etc. - 04.17.24

PTAB Highlights | Takeaways from Recent Decisions in Post-Issuance Proceedings